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Details

Product Status	Obsolete
Core Processor	8051
Core Size	8-Bit
Speed	25MHz
Connectivity	SMBus (2-Wire/I ² C), SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, Temp Sensor, WDT
Number of I/O	8
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2.25K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 4x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	32-LQFP
Supplier Device Package	32-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f007r

TABLE OF CONTENTS

1. SYSTEM OVERVIEW	8
Table 1.1. Product Selection Guide	8
Figure 1.1. C8051F000/05/10/15 Block Diagram	9
Figure 1.2. C8051F001/06/11/16 Block Diagram	10
Figure 1.3. C8051F002/07/12/17 Block Diagram	11
1.1. CIP-51™ CPU	12
Figure 1.4. Comparison of Peak MCU Execution Speeds.....	12
Figure 1.5. On-Board Clock and Reset.....	13
1.2. On-Board Memory.....	14
Figure 1.6. On-Board Memory Map.....	14
1.3. JTAG Debug and Boundary Scan.....	15
Figure 1.7. Debug Environment Diagram	15
1.4. Programmable Digital I/O and Crossbar	16
Figure 1.8. Digital Crossbar Diagram.....	16
1.5. Programmable Counter Array.....	17
Figure 1.9. PCA Block Diagram	17
1.6. Serial Ports.....	17
1.7. Analog to Digital Converter	18
Figure 1.10. ADC Diagram	18
1.8. Comparators and DACs.....	19
Figure 1.11. Comparator and DAC Diagram.....	19
2. ABSOLUTE MAXIMUM RATINGS*.....	20
3. GLOBAL DC ELECTRICAL CHARACTERISTICS	20
4. PINOUT AND PACKAGE DEFINITIONS	21
Table 4.1. Pin Definitions.....	21
Figure 4.1. TQFP-64 Pinout Diagram	23
Figure 4.2. TQFP-64 Package Drawing	24
Figure 4.3. TQFP-48 Pinout Diagram	25
Figure 4.4. TQFP-48 Package Drawing	26
Figure 4.5. LQFP-32 Pinout Diagram	27
Figure 4.6. LQFP-32 Package Drawing	28
5. ADC (12-Bit, C8051F000/1/2/5/6/7 Only).....	29
Figure 5.1. 12-Bit ADC Functional Block Diagram.....	29
5.1. Analog Multiplexer and PGA	29
5.2. ADC Modes of Operation.....	30
Figure 5.2. 12-Bit ADC Track and Conversion Example Timing.....	30
Figure 5.3. Temperature Sensor Transfer Function.....	31
Figure 5.4. AMX0CF: AMUX Configuration Register (C8051F00x)	31
Figure 5.5. AMX0SL: AMUX Channel Select Register (C8051F00x).....	32
Figure 5.6. ADC0CF: ADC Configuration Register (C8051F00x).....	33
Figure 5.7. ADC0CN: ADC Control Register (C8051F00x).....	34
Figure 5.8. ADC0H: ADC Data Word MSB Register (C8051F00x).....	35
Figure 5.9. ADC0L: ADC Data Word LSB Register (C8051F00x).....	35
5.3. ADC Programmable Window Detector.....	36
Figure 5.10. ADC0GTH: ADC Greater-Than Data High Byte Register (C8051F00x)	36
Figure 5.11. ADC0GTL: ADC Greater-Than Data Low Byte Register (C8051F00x)	36
Figure 5.12. ADC0LTH: ADC Less-Than Data High Byte Register (C8051F00x)	36
Figure 5.13. ADC0LTL: ADC Less-Than Data Low Byte Register (C8051F00x).....	36
Figure 5.14. 12-Bit ADC Window Interrupt Examples, Right Justified Data.....	37
Figure 5.15. 12-Bit ADC Window Interrupt Examples, Left Justified Data	37
Figure 5.15. 12-Bit ADC Window Interrupt Examples, Left Justified Data	38

Table 18.2. Oscillator Frequencies for Standard Baud Rates	136
Figure 18.8. SBUF: Serial (UART) Data Buffer Register.....	136
Figure 18.9. SCON: Serial Port Control Register.....	137
19. TIMERS	138
19.1. Timer 0 and Timer 1	138
Figure 19.1. T0 Mode 0 Block Diagram.....	139
Figure 19.2. T0 Mode 2 Block Diagram.....	140
Figure 19.3. T0 Mode 3 Block Diagram.....	141
Figure 19.4. TCON: Timer Control Register.....	142
Figure 19.5. TMOD: Timer Mode Register.....	143
Figure 19.6. CKCON: Clock Control Register.....	144
Figure 19.7. TL0: Timer 0 Low Byte	145
Figure 19.8. TL1: Timer 1 Low Byte	145
Figure 19.9. TH0: Timer 0 High Byte	145
Figure 19.10. TH1: Timer 1 High Byte	145
19.2. Timer 2	146
Figure 19.11. T2 Mode 0 Block Diagram.....	147
Figure 19.12. T2 Mode 1 Block Diagram.....	148
Figure 19.13. T2 Mode 2 Block Diagram.....	149
Figure 19.14. T2CON: Timer 2 Control Register.....	150
Figure 19.15. RCAP2L: Timer 2 Capture Register Low Byte	151
Figure 19.16. RCAP2H: Timer 2 Capture Register High Byte	151
Figure 19.17. TL2: Timer 2 Low Byte	151
Figure 19.18. TH2: Timer 2 High Byte	151
19.3. Timer 3	152
Figure 19.19. Timer 3 Block Diagram.....	152
Figure 19.20. TMR3CN: Timer 3 Control Register	152
Figure 19.21. TMR3RL: Timer 3 Reload Register Low Byte	153
Figure 19.22. TMR3RLH: Timer 3 Reload Register High Byte	153
Figure 19.23. TMR3L: Timer 3 Low Byte	153
Figure 19.24. TMR3H: Timer 3 High Byte	153
20. PROGRAMMABLE COUNTER ARRAY	154
Figure 20.1. PCA Block Diagram	154
20.1. Capture/Compare Modules	155
Table 20.1. PCA0CPM Register Settings for PCA Capture/Compare Modules	155
Figure 20.2. PCA Interrupt Block Diagram.....	155
Figure 20.3. PCA Capture Mode Diagram.....	156
Figure 20.4. PCA Software Timer Mode Diagram.....	157
Figure 20.5. PCA High Speed Output Mode Diagram.....	157
Figure 20.6. PCA PWM Mode Diagram	158
20.2. PCA Counter/Timer.....	159
Table 20.2. PCA Timebase Input Options.....	159
Figure 20.7. PCA Counter/Timer Block Diagram	159
20.3. Register Descriptions for PCA	160
Figure 20.8. PCA0CN: PCA Control Register	160
Figure 20.9. PCA0MD: PCA Mode Register	161
Figure 20.10. PCA0CPMn: PCA Capture/Compare Registers.....	162
Figure 20.11. PCA0L: PCA Counter/Timer Low Byte	163
Figure 20.12. PCA0H: PCA Counter/Timer High Byte	163
Figure 20.13. PCA0CPLn: PCA Capture Module Low Byte	163
Figure 20.14. PCA0CPHn: PCA Capture Module High Byte.....	163
21. JTAG (IEEE 1149.1)	164
Figure 21.1. IR: JTAG Instruction Register	164
21.1. Boundary Scan.....	165

1. SYSTEM OVERVIEW

The C8051F000 family are fully integrated mixed-signal System on a Chip MCUs with a true 12-bit multi-channel ADC (F000/01/02/05/06/07), or a true 10-bit multi-channel ADC (F010/11/12/15/16/17). See the Product Selection Guide in Table 1.1 for a quick reference of each MCUs' feature set. Each has a programmable gain pre-amplifier, two 12-bit DACs, two voltage comparators (except for the F002/07/12/17, which have one), a voltage reference, and an 8051-compatible microcontroller core with 32kbytes of FLASH memory. There are also I2C/SMBus, UART, and SPI serial interfaces implemented in hardware (not "bit-banged" in user software) as well as a Programmable Counter/Timer Array (PCA) with five capture/compare modules. There are also 4 general-purpose 16-bit timers and 4 byte-wide general-purpose digital Port I/O. The C8051F000/01/02/10/11/12 have 256 bytes of RAM and execute up to 20MIPS, while the C8051F005/06/07/15/16/17 have 2304 bytes of RAM and execute up to 25MIPS.

With an on-board VDD monitor, WDT, and clock oscillator, the MCUs are truly stand-alone System-on-a-Chip solutions. Each MCU effectively configures and manages the analog and digital peripherals. The FLASH memory can be reprogrammed even in-circuit, providing non-volatile data storage, and also allowing field upgrades of the 8051 firmware. Each MCU can also individually shut down any or all of the peripherals to conserve power.

On-board JTAG debug support allows non-intrusive (uses no on-chip resources), full speed, in-circuit debug using the production MCU installed in the final application. This debug system supports inspection and modification of memory and registers, setting breakpoints, watchpoints, single stepping, and run and halt commands. All analog and digital peripherals are fully functional when using JTAG debug.

Each MCU is specified for 2.7V-to-3.6V operation over the industrial temperature range (-45C to +85C). The Port I/Os, /RST, and JTAG pins are tolerant for input signals up to 5V. The C8051F000/05/10/15 are available in the 64-pin TQFP (see block diagram in Figure 1.1). The C8051F001/06/11/16 are available in the 48-pin TQFP (see block diagram in Figure 1.2). The C8051F002/07/12/17 are available in the 32-pin LQFP (see block diagram in Figure 1.3).

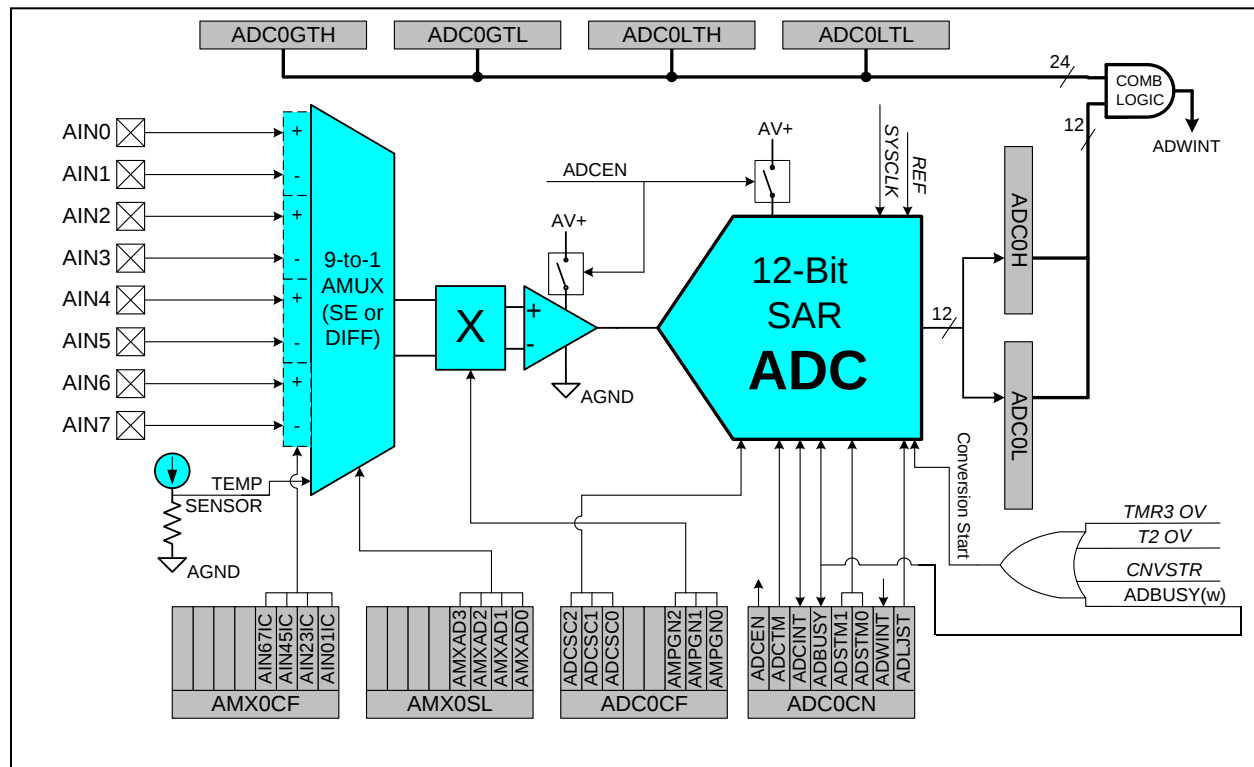
Table 1.1. Product Selection Guide

	MIPS (Peak)	FLASH Memory	RAM	SMBus/I2C	SPI	UART	Timers (16-bit)	Programmable Counter Array	Digital Port I/O's	ADC Resolution (bits)	ADC Max Speed (ksps)	ADC Inputs	Voltage Reference	Temperature Sensor	DAC Resolution	DAC Outputs	Voltage Comparators	Package
C8051F000	20	32k	256	√	√	√	4	√	32	12	100	8	√	√	12	2	2	64TQFP
C8051F001	20	32k	256	√	√	√	4	√	16	12	100	8	√	√	12	2	2	48TQFP
C8051F002	20	32k	256	√	√	√	4	√	8	12	100	4	√	√	12	2	1	32LQFP
C8051F005	25	32k	2304	√	√	√	4	√	32	12	100	8	√	√	12	2	2	64TQFP
C8051F006	25	32k	2304	√	√	√	4	√	16	12	100	8	√	√	12	2	2	48TQFP
C8051F007	25	32k	2304	√	√	√	4	√	8	12	100	4	√	√	12	2	1	32LQFP
C8051F010	20	32k	256	√	√	√	4	√	32	10	100	8	√	√	12	2	2	64TQFP
C8051F011	20	32k	256	√	√	√	4	√	16	10	100	8	√	√	12	2	2	48TQFP
C8051F012	20	32k	256	√	√	√	4	√	8	10	100	4	√	√	12	2	1	32LQFP
C8051F015	25	32k	2304	√	√	√	4	√	32	10	100	8	√	√	12	2	2	64TQFP
C8051F016	25	32k	2304	√	√	√	4	√	16	10	100	8	√	√	12	2	2	48TQFP
C8051F017	25	32k	2304	√	√	√	4	√	8	10	100	4	√	√	12	2	1	32LQFP

5. ADC (12-Bit, C8051F000/1/2/5/6/7 Only)

The ADC subsystem for the C8051F000/1/2/5/6/7 consists of a 9-channel, configurable analog multiplexer (AMUX), a programmable gain amplifier (PGA), and a 100kps, 12-bit successive-approximation-register ADC with integrated track-and-hold and programmable window detector (see block diagram in Figure 5.1). The AMUX, PGA, Data Conversion Modes, and Window Detector are all configurable under software control via the Special Function Register's shown in Figure 5.1. The ADC subsystem (ADC, track-and-hold and PGA) is enabled only when the ADCEN bit in the ADC Control register (ADC0CN, Figure 5.7) is set to 1. The ADC subsystem is in low power shutdown when this bit is 0. The Bias Enable bit (BIASE) in the REF0CN register (see Figure 9.2) must be set to 1 in order to supply bias to the ADC.

Figure 5.1. 12-Bit ADC Functional Block Diagram



5.1. Analog Multiplexer and PGA

Eight of the AMUX channels are available for external measurements while the ninth channel is internally connected to an on-board temperature sensor (temperature transfer function is shown in Figure 5.3). Note that the PGA gain is applied to the temperature sensor reading. AMUX input pairs can be programmed to operate in either the differential or single-ended mode. This allows the user to select the best measurement technique for each input channel, and even accommodates mode changes “on-the-fly”. The AMUX defaults to all single-ended inputs upon reset. There are two registers associated with the AMUX: the Channel Selection register AMX0SL (Figure 5.5), and the Configuration register AMX0CF (Figure 5.4). The table in Figure 5.5 shows AMUX functionality by channel for each possible configuration. The PGA amplifies the AMUX output signal by an amount determined by the AMPGN2-0 bits in the ADC Configuration register, ADC0CF (Figure 5.6). The PGA can be software-programmed for gains of 0.5, 1, 2, 4, 8 or 16. It defaults to unity gain on reset.

Figure 6.6. ADC0CF: ADC Configuration Register (C8051F01x)

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
ADCSC2	ADCSC1	ADCSC0	-	-	AMPGN2	AMPGN1	AMPGN0	01100000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xBC

Bits7-5: ADCSC2-0: ADC SAR Conversion Clock Period Bits
 000: SAR Conversion Clock = 1 System Clock
 001: SAR Conversion Clock = 2 System Clocks
 010: SAR Conversion Clock = 4 System Clocks
 011: SAR Conversion Clock = 8 System Clocks
 1xx: SAR Conversion Clock = 16 Systems Clocks
 (Note: Conversion clock should be $\leq$ 2MHz.)
 Bits4-3: UNUSED. Read = 00b; Write = don't care
 Bits2-0: AMPGN2-0: ADC Internal Amplifier Gain
 000: Gain = 1
 001: Gain = 2
 010: Gain = 4
 011: Gain = 8
 10x: Gain = 16
 11x: Gain = 0.5

Figure 6.8. ADC0H: ADC Data Word MSB Register (C8051F01x)

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xBF

Bits7-0: ADC Data Word Bits
 For ADLJST = 1: Upper 8-bits of the 10-bit ADC Data Word.
 For ADLJST = 0: Bits7-2 are the sign extension of Bit1. Bits 1-0 are the upper 2-bits of the 10-bit ADC Data Word.

Figure 6.9. ADC0L: ADC Data Word LSB Register (C8051F01x)

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xBE

Bits7-0: ADC Data Word Bits
 For ADLJST = 1: Bits7-6 are the lower 2-bits of the 10-bit ADC Data Word. Bits5-0 will always read 0.
 For ADLJST = 0: Bits7-0 are the lower 8-bits of the 10-bit ADC Data Word.

NOTE: Resulting 10-bit ADC Data Word appears in the ADC Data Word Registers as follows:
 ADC0H[1:0]:ADC0L[7:0], if ADLJST = 0
 (ADC0H[7:2] will be sign extension of ADC0H.1 if a differential reading, otherwise = 000000b)

ADC0H[7:0]:ADC0L[7:6], if ADLJST = 1
 (ADC0L[5:0] = 000000b)

EXAMPLE: ADC Data Word Conversion Map, AIN0 Input in Single-Ended Mode
 (AMX0CF=0x00, AMX0SL=0x00)

AIN0 – AGND (Volts)	ADC0H:ADC0L (ADLJST = 0)	ADC0H:ADC0L (ADLJST = 1)
REF x (1023/1024)	0x03FF	0xFFC0
REF x 1/2	0x0200	0x8000
REF x (511/1024)	0x01FF	0x7FC0
0	0x0000	0x0000

EXAMPLE: ADC Data Word Conversion Map, AIN0-AIN1 Differential Input Pair
 (AMX0CF=0x01, AMX0SL=0x00)

AIN0 – AIN1 (Volts)	ADC0H:ADC0L (ADLJST = 0)	ADC0H:ADC0L (ADLJST = 1)
REF x (511/512)	0x01FF	0x7FC0
0	0x0000	0x0000
-REF x (1/512)	0xFFFF	0xFFC0
-REF	0xFE00	0x8000

Figure 6.14. 10-Bit ADC Window Interrupt Examples, Right Justified Data

Input Voltage (AD0 - AGND)	ADC Data Word	
REF x (1023/1024)	0x03FF	ADWINT not affected
	0x0201	
REF x (512/1024)	0x0200	ADC0LTH:ADC0LTL
	0x01FF	ADWINT=1
	0x0101	
REF x (256/1024)	0x0100	ADC0GTH:ADC0GTL
	0x00FF	ADWINT not affected
0	0x0000	

Given:

AMX0SL = 0x00, AMX0CF = 0x00, ADLJST = 0,
ADC0LTH:ADC0LTL = 0x0200,
ADC0GTH:ADC0GTL = 0x0100.

An ADC End of Conversion will cause an ADC Window Compare Interrupt (ADWINT=1) if the resulting ADC Data Word is < 0x0200 and > 0x0100.

Input Voltage (AD0 - AGND)	ADC Data Word	
REF x (1023/1024)	0x03FF	ADWINT=1
	0x0201	
REF x (512/1024)	0x0200	ADC0GTH:ADC0GTL
	0x01FF	ADWINT not affected
	0x0101	
REF x (256/1024)	0x0100	ADC0LTH:ADC0LTL
	0x00FF	ADWINT=1
0	0x0000	

Given:

AMX0SL = 0x00, AMX0CF = 0x00, ADLJST = 0,
ADC0LTH:ADC0LTL = 0x0100,
ADC0GTH:ADC0GTL = 0x0200.

An ADC End of Conversion will cause an ADC Window Compare Interrupt (ADWINT=1) if the resulting ADC Data Word is < 0x0100 or > 0x0200.

Input Voltage (AD0 - AD1)	ADC Data Word	
REF x (511/512)	0x01FF	ADWINT not affected
	0x0101	
REF x (256/512)	0x0100	ADC0LTH:ADC0LTL
	0x00FF	ADWINT=1
	0x0000	
REF x (-1/512)	0xFFFF	ADC0GTH:ADC0GTL
	0xFFFE	ADWINT not affected
-REF	0xFE00	

Given:

AMX0SL = 0x00, AMX0CF = 0x01, ADLJST = 0,
ADC0LTH:ADC0LTL = 0x0100,
ADC0GTH:ADC0GTL = 0xFFFF.

An ADC End of Conversion will cause an ADC Window Compare Interrupt (ADWINT=1) if the resulting ADC Data Word is < 0x0100 and > 0xFFFF. (Two's Complement math, 0xFFFF = -1.)

Input Voltage (AD0 - AD1)	ADC Data Word	
REF x (511/512)	0x01FF	ADWINT=1
	0x0101	
REF x (256/512)	0x0100	ADC0GTH:ADC0GTL
	0x00FF	ADWINT not affected
	0x0000	
REF x (-1/512)	0xFFFF	ADC0LTH:ADC0LTL
	0xFFFE	ADWINT=1
-REF	0xFE00	

Given:

AMX0SL = 0x00, AMX0CF = 0x01, ADLJST = 0,
ADC0LTH:ADC0LTH = 0xFFFF,
ADC0GTH:ADC0GTL = 0x0100.

An ADC End of Conversion will cause an ADC Window Compare Interrupt (ADWINT=1) if the resulting ADC Data Word is < 0xFFFF or > 0x0100. (Two's Complement math, 0xFFFF = -1.)

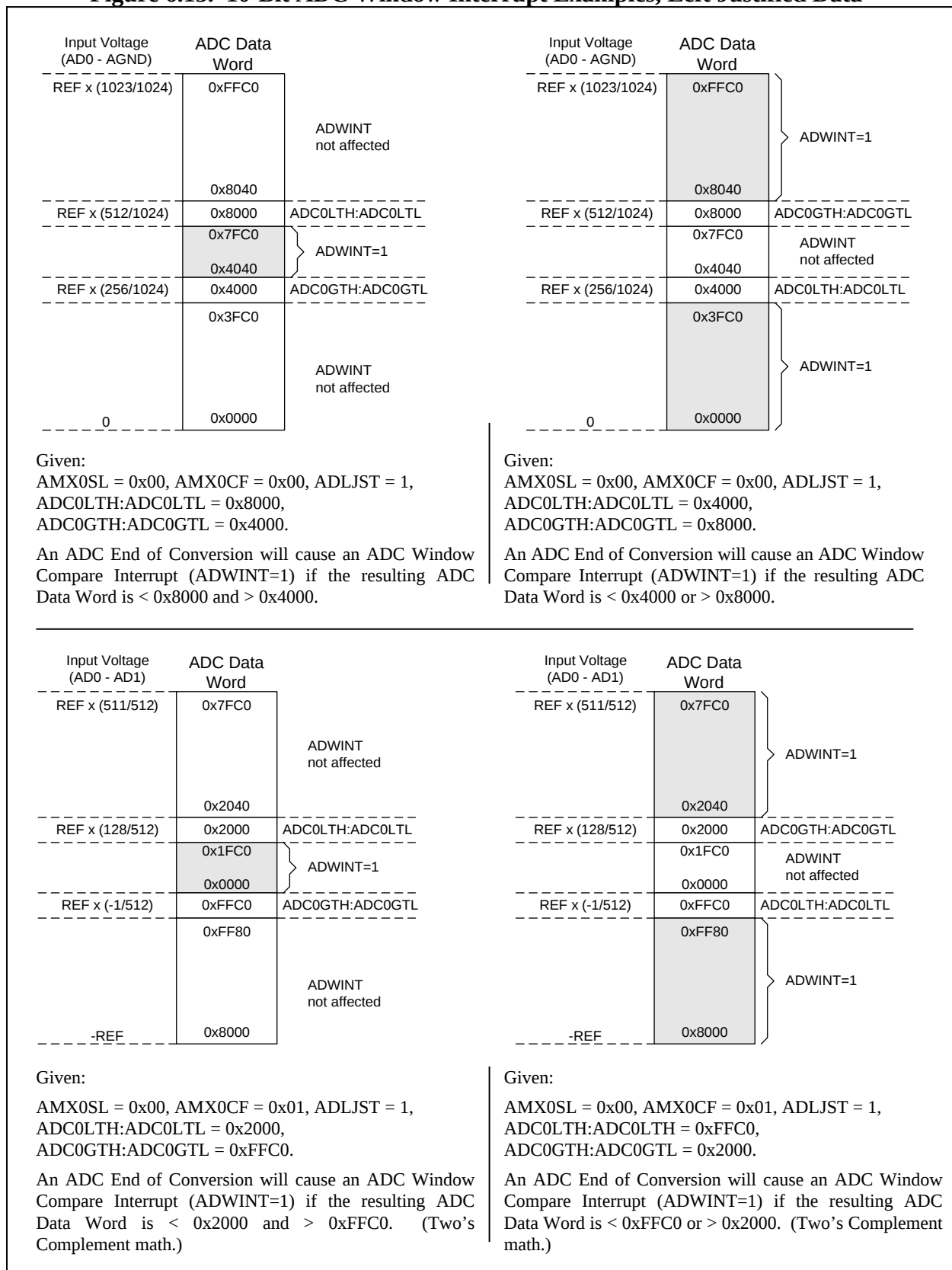
Figure 6.15. 10-Bit ADC Window Interrupt Examples, Left Justified Data

Figure 9.2. REF0CN: Reference Control Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
-	-	-	-	-	TEMPE	BIASE	REFBE	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xD1

Bits7-3: UNUSED. Read = 00000b; Write = don't care

Bit2: TEMPE: Temperature Sensor Enable Bit
0: Internal Temperature Sensor Off.
1: Internal Temperature Sensor On.

Bit1: BIASE: Bias Enable Bit for ADC and DAC's
0: Internal Bias Off.
1: Internal Bias On (required for use of ADC or DAC's).

Bit0: REFBE: Internal Voltage Reference Buffer Enable Bit
0: Internal Reference Buffer Off. System reference can be driven from external source on VREF pin.
1: Internal Reference Buffer On. System reference provided by internal voltage reference.

Table 9.1. Reference Electrical Characteristics

VDD = 3.0V, AV+ = 3.0V, -40°C to +85°C unless otherwise specified.

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
INTERNAL REFERENCE (REFBE = 1)					
Output Voltage	25°C ambient	2.34	2.43	2.50	V
VREF Short Circuit Current				30	mA
VREF Power Supply Current (supplied by AV+)			50		μA
VREF Temperature Coefficient			15		ppm/°C
Load Regulation	Load = (0-to-200μA) to AGND (Note 1)		0.5		ppm/μA
VREF Turn-on Time1	4.7μF tantalum, 0.1μF ceramic bypass		2		ms
VREF Turn-on Time2	0.1μF ceramic bypass		20		μs
VREF Turn-on Time3	no bypass cap		10		μs
EXTERNAL REFERENCE (REFBE = 0)					
Input Voltage Range		1.00		(AV+) - 0.3V	V
Input Current			0	1	μA

Note 1: The reference can only source current. When driving an external load, it is recommended to add a load resistor to AGND.

register configured for accessing the external data memory space. Refer to Section 11 (Flash Memory) for further details.

Figure 10.6. PSW: Program Status Word

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
CY	AC	F0	RS1	RS0	OV	F1	PARITY	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0 (bit addressable)	SFR Address: 0xD0

Bit7: CY: Carry Flag.
This bit is set when the last arithmetic operation results in a carry (addition) or a borrow (subtraction). It is cleared to 0 by all other arithmetic operations.

Bit6: AC: Auxiliary Carry Flag.
This bit is set when the last arithmetic operation results in a carry into (addition) or a borrow from (subtraction) the high order nibble. It is cleared to 0 by all other arithmetic operations.

Bit5: F0: User Flag 0.
This is a bit-addressable, general purpose flag for use under software control.

Bits4-3: RS1-RS0: Register Bank Select.
These bits select which register bank is used during register accesses.

RS1	RS0	Register Bank	Address
0	0	0	0x00-0x07
0	1	1	0x08-0x0F
1	0	2	0x10-0x17
1	1	3	0x18-0x1F

Note: Any instruction which changes the RS1-RS0 bits must not be immediately followed by the “MOV Rn, A” instruction.

Bit2: OV: Overflow Flag.
This bit is set to 1 under the following circumstances:

- An ADD, ADDC, or SUBB instruction causes a sign-change overflow.
- A MUL instruction results in an overflow (result is greater than 255) .
- A DIV instruction causes a divide-by-zero condition.

The OV bit is cleared to 0 by the ADD, ADDC, SUBB, MUL, and DIV instructions in all other cases.

Bit1: F1: User Flag 1.
This is a bit-addressable, general purpose flag for use under software control.

Bit0: PARITY: Parity Flag.
(Read only)
This bit is set to 1 if the sum of the eight bits in the accumulator is odd and cleared if the sum is even.

Table 10.4. Interrupt Summary

Interrupt Source	Interrupt Vector	Priority Order	Interrupt-Pending Flag	Enable
Reset	0x0000	Top	None	Always enabled
External Interrupt 0 (/INT0)	0x0003	0	IE0 (TCON.1)	EX0 (IE.0)
Timer 0 Overflow	0x000B	1	TF0 (TCON.5)	ET0 (IE.1)
External Interrupt 1 (/INT1)	0x0013	2	IE1 (TCON.3)	EX1 (IE.2)
Timer 1 Overflow	0x001B	3	TF1 (TCON.7)	ET1 (IE.3)
Serial Port (UART)	0x0023	4	RI (SCON.0) TI (SCON.1)	ES (IE.4)
Timer 2 Overflow (or EXF2)	0x002B	5	TF2 (T2CON.7)	ET2 (IE.5)
Serial Peripheral Interface	0x0033	6	SPIF (SPI0CN.7) WCOL (SPI0CN.6) MODF (SPI0CN.5) RXOVRN (SPI0CN.4)	ESPI0 (EIE1.0)
SMBus Interface	0x003B	7	SI (SMB0CN.3)	ESMB0 (EIE1.1)
ADC0 Window Comparison	0x0043	8	ADWINT (ADC0CN.2)	EWADC0 (EIE1.2)
Programmable Counter Array 0	0x004B	9	CF (PCA0CN.7) CCFn (PCA0CN.n)	EPCA0 (EIE1.3)
Comparator 0 Falling Edge	0x0053	10	CP0FIF (CPT0CN.4)	ECP0F (EIE1.4)
Comparator 0 Rising Edge	0x005B	11	CP0RIF (CPT0CN.5)	ECP0R (EIE1.5)
Comparator 1 Falling Edge	0x0063	12	CP1FIF (CPT1CN.4)	ECP1F (EIE1.6)
Comparator 1 Rising Edge	0x006B	13	CP1RIF (CPT1CN.5)	ECP1R (EIE1.7)
Timer 3 Overflow	0x0073	14	TF3 (TMR3CN.7)	ET3 (EIE2.0)
ADC0 End of Conversion	0x007B	15	ADCINT (ADC0CN.5)	EADC0 (EIE2.1)
External Interrupt 4	0x0083	16	IE4 (PRT1IF.4)	EX4 (EIE2.2)
External Interrupt 5	0x008B	17	IE5 (PRT1IF.5)	EX5 (EIE2.3)
External Interrupt 6	0x0093	18	IE6 (PRT1IF.6)	EX6 (EIE2.4)
External Interrupt 7	0x009B	19	IE7 (PRT1IF.7)	EX7 (EIE2.5)
Unused Interrupt Location	0x00A3	20	None	Reserved (EIE2.6)
External Crystal OSC Ready	0x00AB	21	XTLVLD (OSCXCN.7)	EXVLD (EIE2.7)

10.4.3. Interrupt Priorities

Each interrupt source can be individually programmed to one of two priority levels: low or high. A low priority interrupt service routine can be preempted by a high priority interrupt. A high priority interrupt cannot be preempted. Each interrupt has an associated interrupt priority bit in an SFR (IP-EIP2) used to configure its priority level. Low priority is the default. If two interrupts are recognized simultaneously, the interrupt with the higher priority is serviced first. If both interrupts have the same priority level, a fixed priority order is used to arbitrate.

10.4.4. Interrupt Latency

Interrupt response time depends on the state of the CPU when the interrupt occurs. Pending interrupts are sampled and priority decoded each system clock cycle. Therefore, the fastest possible response time is 5 system clock cycles: 1 clock cycle to detect the interrupt and 4 clock cycles to complete the LCALL to the ISR. If an interrupt is pending when a RETI is executed, a single instruction is executed before an LCALL is made to service the pending interrupt. Therefore, the maximum response time for an interrupt (when no other interrupt is currently being serviced or the new interrupt is of greater priority) occurs when the CPU is performing an RETI instruction followed by a DIV as the next instruction. In this case, the response time is 18 system clock cycles: 1 clock cycle to detect the interrupt, 5 clock cycles to execute the RETI, 8 clock cycles to complete the DIV instruction and 4 clock cycles to execute the LCALL to the ISR. If the CPU is executing an ISR for an interrupt with equal or higher priority, the new interrupt will not be serviced until the current ISR completes, including the RETI and following instruction.

Figure 10.13. EIP1: Extended Interrupt Priority 1

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
PCP1R	PCP1F	PCP0R	PCP0F	PPCA0	PWADC0	PSMB0	PSPI0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xF6
Bit7: PCP1R: Comparator 1 (CP1) Rising Interrupt Priority Control. This bit sets the priority of the CP1 interrupt. 0: CP1 rising interrupt set to low priority level. 1: CP1 rising interrupt set to high priority level. Bit6: PCP1F: Comparator 1 (CP1) Falling Interrupt Priority Control. This bit sets the priority of the CP1 interrupt. 0: CP1 falling interrupt set to low priority level. 1: CP1 falling interrupt set to high priority level. Bit5: PCP0R: Comparator 0 (CP0) Rising Interrupt Priority Control. This bit sets the priority of the CP0 interrupt. 0: CP0 rising interrupt set to low priority level. 1: CP0 rising interrupt set to high priority level. Bit4: PCP0F: Comparator 0 (CP0) Falling Interrupt Priority Control. This bit sets the priority of the CP0 interrupt. 0: CP0 falling interrupt set to low priority level. 1: CP0 falling interrupt set to high priority level. Bit3: PPCA0: Programmable Counter Array (PCA0) Interrupt Priority Control. This bit sets the priority of the PCA0 interrupt. 0: PCA0 interrupt set to low priority level. 1: PCA0 interrupt set to high priority level. Bit2: PWADC0: ADC0 Window Comparator Interrupt Priority Control. This bit sets the priority of the ADC0 Window interrupt. 0: ADC0 Window interrupt set to low priority level. 1: ADC0 Window interrupt set to high priority level. Bit1: PSMB0: SMBus 0 Interrupt Priority Control. This bit sets the priority of the SMBus interrupt. 0: SMBus interrupt set to low priority level. 1: SMBus interrupt set to high priority level. Bit0: PSPI0: Serial Peripheral Interface 0 Interrupt Priority Control. This bit sets the priority of the SPI0 interrupt. 0: SPI0 interrupt set to low priority level. 1: SPI0 interrupt set to high priority level.								

Figure 10.14. EIP2: Extended Interrupt Priority 2

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
PXVLD	-	PX7	PX6	PX5	PX4	PADC0	PT3	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xF7
Bit7: PXVLD: External Clock Source Valid (XTLVLD) Interrupt Priority Control. This bit sets the priority of the XTLVLD interrupt. 0: XTLVLD interrupt set to low priority level. 1: XTLVLD interrupt set to high priority level. Bit6: Reserved: Must write 0. Reads 0. Bit5: PX7: External Interrupt 7 Priority Control. This bit sets the priority of the External Interrupt 7. 0: External Interrupt 7 set to low priority level. 1: External Interrupt 7 set to high priority level. Bit4: PX6: External Interrupt 6 Priority Control. This bit sets the priority of the External Interrupt 6. 0: External Interrupt 6 set to low priority level. 1: External Interrupt 6 set to high priority level. Bit3: PX5: External Interrupt 5 Priority Control. This bit sets the priority of the External Interrupt 5. 0: External Interrupt 5 set to low priority level. 1: External Interrupt 5 set to high priority level. Bit2: PX4: External Interrupt 4 Priority Control. This bit sets the priority of the External Interrupt 4. 0: External Interrupt 4 set to low priority level. 1: External Interrupt 4 set to high priority level. Bit1: PADC0: ADC End of Conversion Interrupt Priority Control. This bit sets the priority of the ADC0 End of Conversion Interrupt. 0: ADC0 End of Conversion interrupt set to low priority level. 1: ADC0 End of Conversion interrupt set to high priority level. Bit0: PT3: Timer 3 Interrupt Priority Control. This bit sets the priority of the Timer 3 interrupts. 0: Timer 3 interrupt set to low priority level. 1: Timer 3 interrupt set to high priority level.								

11.2. Non-volatile Data Storage

The Flash memory can be used for non-volatile data storage as well as program code. This allows data such as calibration coefficients to be calculated and stored at run time. Data is written using the MOVX instruction and read using the MOVC instruction.

The MCU incorporates an additional 128-byte sector of Flash memory located at 0x8000 – 0x807F. This sector can be used for program code or data storage. However, its smaller sector size makes it particularly well suited as general purpose, non-volatile scratchpad memory. Even though Flash memory can be written a single byte at a time, an entire sector must be erased first. In order to change a single byte of a multi-byte data set, the data must be moved to temporary storage. Next, the sector is erased, the data set updated and the data set returned to the original sector. The 128-byte sector-size facilitates updating data without wasting program memory space by allowing the use of internal data RAM for temporary storage. (A normal 512-byte sector is too large to be stored in the 256-byte internal data memory.)

11.3. Security Options

The CIP-51 provides security options to protect the Flash memory from inadvertent modification by software as well as prevent the viewing of proprietary program code and constants. The Program Store Write Enable (PSCTL.0) and the Program Store Erase Enable (PSCTL.1) bits protect the Flash memory from accidental modification by software. These bits must be explicitly set to logic 1 before software can modify the Flash memory. Additional security features prevent proprietary program code and data constants from being read or altered across the JTAG interface or by software running on the system controller.

A set of security lock bytes stored at 0x7DFE and 0x7DFF protect the Flash program memory from being read or altered across the JTAG interface. Each bit in a security lock-byte protects one 4kbyte block of memory. Clearing a bit to logic 0 in a Read lock byte prevents the corresponding block of Flash memory from being read across the JTAG interface. Clearing a bit in the Write/Erase lock byte protects the block from JTAG erasures and/or writes. The Read lock byte is at location 0x7DFF. The Write/Erase lock byte is located at 0x7DFE. Figure 11.2 shows the location and bit definitions of the security bytes. The 512-byte sector containing the lock bytes can be written to, but not erased by software. Writing to the reserved area should not be performed.

Figure 11.1. PSCTL: Program Store RW Control

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
-	-	-	-	-	-	PSEE	PSWE	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0x8F
Bits7-2: UNUSED. Read = 000000b, Write = don't care.								
Bit1: PSEE: Program Store Erase Enable. Setting this bit allows an entire page of the Flash program memory to be erased provided the PSWE bit is also set. After setting this bit, a write to Flash memory using the MOVX instruction will erase the entire page that contains the location addressed by the MOVX instruction. The value of the data byte written does not matter. 0: Flash program memory erasure disabled. 1: Flash program memory erasure enabled.								
Bit0: PSWE: Program Store Write Enable. Setting this bit allows writing a byte of data to the Flash program memory using the MOVX instruction. The location must be erased before writing data. 0: Write to Flash program memory disabled. 1: Write to Flash program memory enabled.								

Table 13.1. Reset Electrical Characteristics

-40°C to +85°C unless otherwise specified.

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
/RST Output Low Voltage	$I_{OL} = 8.5\text{mA}$, $V_{DD} = 2.7$ to 3.6V			0.6	V
/RST Input High Voltage		$0.7 \times V_{DD}$			V
/RST Input Low Voltage				$0.3 \times V_{DD}$	V
/RST Input Leakage Current	/RST = 0.0V		20		μA
VDD for /RST Output Valid		1.0			V
AV+ for /RST Output Valid		1.0			V
VDD POR Threshold (V_{RST})		2.40	2.55	2.70	V
Reset Time Delay	/RST rising edge after crossing reset threshold	80	100	120	ms
Missing Clock Detector Timeout	Time from last system clock to reset generation	100	220	500	μs

Table 15.1. Crossbar Priority Decode

	P0								P1								P2							
PIN I/O	0	1	2	3	4	5	6	7	0	1	2	3	4	5	6	7	0	1	2	3	4	5	6	7
SDA	●																							
SCL		●																						
SCK	●		●																					
MISO		●		●																				
MOSI			●		●																			
NSS				●		●																		
TX	●		●		●		●																	
RX		●		●		●		●																
CEX0	●		●		●		●		●															
CEX1		●		●		●		●		●														
CEX2			●		●		●		●		●													
CEX3				●		●		●		●		●												
CEX4					●		●		●		●		●											
ECI	●	●	●	●	●	●	●	●	●	●	●	●	●	●										
CP0	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●									
CP1	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●								
T0	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●							
/INT0	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●						
T1	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●					
/INT1	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●				
T2	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●			
T2EX	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●		
/SYSCLK	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	
CNVSTR	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	●

In the Priority Decode Table, a dot (•) is used to show the external Port I/O pin (column) to which each signal (row) can be assigned by the user application code via programming registers XBR2, XBR1, and XBR0.

Figure 15.8. P1: Port1 Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
P1.7	P1.6	P1.5	P1.4	P1.3	P1.2	P1.1	P1.0	11111111
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
						(bit addressable)		0x90

Bits7-0: P1.[7:0]
 (Write – Output appears on I/O pins per XBR0, XBR1, and XBR2 registers)
 0: Logic Low Output.
 1: Logic High Output (high-impedance if corresponding PRT1CF.n bit = 0)
 (Read – Regardless of XBR0, XBR1, and XBR2 Register settings).
 0: P1.n pin is logic low.
 1: P1.n pin is logic high.

Figure 15.9. PRT1CF: Port1 Configuration Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0xA5

Bits7-0: PRT1CF.[7:0]: Output Configuration Bits for P1.7-P1.0 (respectively)
 0: Corresponding P1.n Output mode is Open-Drain.
 1: Corresponding P1.n Output mode is Push-Pull.

Figure 15.10. PRT1IF: Port1 Interrupt Flag Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
IE7	IE6	IE5	IE4	-	-	-	-	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0xAD

Bit7: IE7: External Interrupt 7 Pending Flag.
 0: No falling edge detected on P1.7.
 1: This flag is set by hardware when a falling edge on P1.7 is detected.

Bit6: IE6: External Interrupt 6 Pending Flag.
 0: No falling edge detected on P1.6.
 1: This flag is set by hardware when a falling edge on P1.6 is detected.

Bit5: IE5: External Interrupt 5 Pending Flag.
 0: No falling edge detected on P1.5.
 1: This flag is set by hardware when a falling edge on P1.5 is detected.

Bit4: IE4: External Interrupt 4 Pending Flag.
 0: No falling edge detected on P1.4.
 1: This flag is set by hardware when a falling edge on P1.4 is detected.

Bits3-0: UNUSED. Read = 0000b, Write = don't care.

Figure 19.4. TCON: Timer Control Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
TF1	TR1	TF0	TR0	IE1	IT1	IE0	IT0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0 (bit addressable)	SFR Address: 0x88
Bit7: TF1: Timer 1 Overflow Flag. Set by hardware when Timer 1 overflows. This flag can be cleared by software but is automatically cleared when the CPU vectors to the Timer 1 interrupt service routine. 0: No Timer 1 overflow detected. 1: Timer 1 has overflowed. Bit6: TR1: Timer 1 Run Control. 0: Timer 1 disabled. 1: Timer 1 enabled. Bit5: TF0: Timer 0 Overflow Flag. Set by hardware when Timer 0 overflows. This flag can be cleared by software but is automatically cleared when the CPU vectors to the Timer 0 interrupt service routine. 0: No Timer 0 overflow detected. 1: Timer 0 has overflowed. Bit4: TR0: Timer 0 Run Control. 0: Timer 0 disabled. 1: Timer 0 enabled. Bit3: IE1: External Interrupt 1. This flag is set by hardware when an edge/level of type defined by IT1 is detected. It can be cleared by software but is automatically cleared when the CPU vectors to the External Interrupt 1 service routine if IT1 = 1. This flag is the inverse of the /INT1 input signal's logic level when IT1 = 0. Bit2: IT1: Interrupt 1 Type Select. This bit selects whether the configured /INT1 signal will detect falling edge or active-low level-sensitive interrupts. 0: /INT1 is level triggered. 1: /INT1 is edge triggered. Bit1: IE0: External Interrupt 0. This flag is set by hardware when an edge/level of type defined by IT0 is detected. It can be cleared by software but is automatically cleared when the CPU vectors to the External Interrupt 0 service routine if IT0 = 1. This flag is the inverse of the /INT0 input signal's logic level when IT0 = 0. Bit0: IT0: Interrupt 0 Type Select. This bit selects whether the configured /INT0 signal will detect falling edge or active-low level-sensitive interrupts. 0: /INT0 is level triggered. 1: /INT0 is edge triggered.								

20.2. PCA Counter/Timer

The 16-bit PCA counter/timer consists of two 8-bit SFRs: PCA0L and PCA0H. PCA0H is the high byte (MSB) of the 16-bit counter/timer and PCA0L is the low byte (LSB). Reading PCA0L automatically latches the value of PCA0H at the same time. By reading the PCA0L Register first, this allows the PCA0H value to be held (at the time PCA0L was read) until the user reads the PCA0H Register. Reading PCA0H or PCA0L does not disturb the counter operation. The CPS1 and CPS0 bits in the PCA0MD register select the timebase for the counter/timer as shown in Table 20.2.

When the counter/timer overflows from 0xFFFF to 0x0000, the Counter Overflow Flag (CF) in PCA0MD is set to logic 1 and an interrupt request is generated if CF interrupts are enabled. Setting the ECF bit in PCA0MD to logic 1 enables the CF flag to generate an interrupt request. The CF bit is not automatically cleared by hardware when the CPU vectors to the interrupt service routine, and must be cleared by software. (Note: PCA0 interrupts must be globally enabled before CF interrupts are recognized. PCA0 interrupts are globally enabled by setting the EA bit (IE.7) and the EPCA0 bit in EIE1 to logic 1.) Clearing the CIDL bit in the PCA0MD register allows the PCA to continue normal operation while the microcontroller core is in Idle mode.

Table 20.2. PCA Timebase Input Options

CPS1	CPS0	Timebase
0	0	System clock divided by 12
0	1	System clock divided by 4
1	0	Timer 0 overflow
1	1	High-to-low transitions on ECI (max rate = system clock divided by 4)

Figure 20.7. PCA Counter/Timer Block Diagram

